

FEATURES

- ESD Protection for RS-232 I/O Pins
 - ±15 kV (Human-Body Model)
 - ±8 kV (IEC 61000-4-2, Contact Discharge)
 - ±15 kV (IEC 61000-4-2, Air-Gap Discharge)
- 300-µA Operating Supply Current
- 1-µA Low-Power Standby Mode (With Receivers Active)
- Designed to Transmit at a Data Rate of 460 kbps
- Auto-Powerdown Plus Option Features Flexible Power-Saving Mode
- Operates From a Single 2.25-V to 3-V V_{CC} Supply
- Designed to be Interchangeable With Industry Standard '3318 Devices

APPLICATIONS

- Battery-Powered Systems
- PDAs
- Cellular Phones
- Notebooks
- Hand-Held Equipment
- Pagers

DESCRIPTION/ORDERING INFORMATION

The TRS3318E is a dual-driver, dual-receiver, RS-232-compatible transceiver. The device features auto-powerdown plus and enhanced electrostatic discharge (ESD) protection integrated into the chip. Driver output and receiver input are protected to ± 15 kV using the IEC 61000-4-2 Air-Gap Discharge method, ± 8 kV using the IEC 61000-4-2 Contact Discharge method, and ± 15 kV using the Human-Body Model (HBM).

The device operates at a data rate of 460 kbps. The transceiver has a proprietary low-dropout driver output stage, enabling RS-232-compatible operation from a 2.25-V to 3-V supply with a dual charge pump. The charge pump requires only four 0.1- μ F capacitors and features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The TRS3318E achieves a 1- μ A supply current using the auto-powerdown feature. This device automatically enters a low-power power-down mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. The device turns on again when it senses a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

This device is available in two space-saving packages: 20-pin SSOP and 20-pin TSSOP.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

DB OR PW PACKAGE (TOP VIEW)						
C1+[2 V+[3 C1-[4 C2+[5 C2-[6 V-[7 DOUT2[8	20 FORCEOFF 19 V _{CC} 18 GND 17 DOUT1 16 RIN1 15 ROUT1 14 FORCEON 13 DIN1 12 DIN2 11 INVALID					

TRS3318E 2.5-V 460-kbps RS-232 TRANSCEIVER WITH ±15-kV ESD PROTECTION

T _A	PAC	KAGE ⁽¹⁾⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING				
0°C to 70°C	SSOP – DB	Tube of 70	TRS3318ECDB	- RV318EC				
	550P - DB	Reel of 2000	TRS3318ECDBR	- RV3IOEC				
	7000D DW	Tube of 70	TRS3318ECPW					
	TSSOP – PW	Reel of 2000	TRS3318ECPWR	RV318EC				
		Tube of 70	TRS3318EIDB					
40°C to 05°C	SSOP – DB	Reel of 2000	TRS3318EIDBR	RV318EI				
–40°C to 85°C		Tube of 70	TRS3318EIPW					
	TSSOP – PW	Reel of 2000	TRS3318EIPWR	RV318EI				

ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

DETAILED DESCRIPTION

Flexible control options for power management are featured when the serial port and driver inputs are inactive. The auto-powerdown plus feature functions when FORCEON is low and FORCEOFF is high. During this mode of operation, if the device does not sense valid signal transitions on all receiver and driver inputs for approximately 30 s, the built-in charge pump and drivers are powered down, reducing the supply current to 1 μ A. By disconnecting the serial port or placing the peripheral drivers off, auto-powerdown plus can be disabled when FORCEON and FORCEOFF are high. With auto-powerdown plus enabled, the device activates automatically when a valid signal is applied to any receiver or driver input. INVALID is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V, or has been between -0.3 V and 0.3 V for less than 30 μ s (typical number). INVALID is low (invalid data) if all receiver input voltage are between -0.3 V and 0.3 V for more than 30 μ s (typical number).

TRS3318E 2.5-V 460-kbps RS-232 TRANSCEIVER WITH $\pm 15\text{-kV}$ ESD PROTECTION

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	INPUT CO	ONDITIONS			OUTPUT	STATES		
FORCEON	FORCEOFF	RECEIVER OR DRIVER EDGE WITHIN 30 s	VALID RS-232 LEVEL PRESENT AT RECEIVER	DRIVER	RECEIVER	INVALID	READY	OPERATING MODE
	I	I	Auto-Powerd	own Plus Co	onditions			I.
Н	Н	No	No	Active	Active	L	н	Normal operation, auto-powerdown plus disabled
Н	Н	No	Yes	Active	Active	Н	н	Normal operation, auto-powerdown plus disabled
L	Н	Yes	No	Active	Active	L	н	Normal operation, auto-powerdown plus enabled
L	Н	Yes	Yes	Active	Active	Н	н	Normal operation, auto-powerdown plus enabled
L	Н	No	No	Z	Active	L	L	Power down, auto-powerdown plus enabled
L	Н	No	Yes	Z	Active	н	L	Power down, auto-powerdown plus enabled
х	L	х	No	Z	Active	L	L	Manual power down
х	L	х	Yes	Z	Active	Н	L	Manual power down
			Auto-Powe	erdown Cond	litions			
INVALID	INVALID	х	No	Z	Active	L	L	Power down, auto-powerdown enabled
INVALID	INVALID	х	Yes	Active	Active	Н	н	Normal operation, auto-powerdown enabled

FUNCTION TABLE⁽¹⁾

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

TRS3318E 2.5-V 460-kbps RS-232 TRANSCEIVER WITH ±15-kV ESD PROTECTION

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TERMINAL FUNCTIONS

TERMINAL		DESCRIPTION				
NAME	NO.	DESCRIPTION				
C1+	2	Positive voltage-doubler charge-pump capacitor				
C1-	4	Negative voltage-doubler charge-pump capacitor				
C2+	5	Positive inverting charge-pump capacitor				
C2-	6	Negative inverting charge-pump capacitor				
DIN	12, 13	CMOS driver inputs				
DOUT	8, 17	RS-232 driver outputs				
FORCEOFF	20	Force-off input, active low. Drive low to power down transmitters, receivers, and charge pump. This overrides auto-powerdown and FORCEON (see Function Table).				
FORCEON	14	Force-on input, active high. Drive high to override auto-powerdown, keeping transmitters and receivers on (FORCEOFF must be high) (see Function Table).				
GND	18	Ground				
INVALID	11	Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input.				
READY	1	Ready to transmit output, active high. READY is enabled high when V– goes below –3.5 V and the device is ready to transmit.				
RIN	9, 16	RS-232 receiver inputs				
ROUT	10, 15	CMOS receiver outputs				
V+	3	$2 \times V_{CC}$ generated by the charge pump				
V–	7	$-2 \times V_{CC}$ generated by the charge pump				
V _{CC}	19	2.25-V to 3-V single-supply voltage				

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{CC} to GND		-0.3	6	V
V+ to GND ⁽²⁾		-0.3	7	V
V- to GND ⁽²⁾		-7	0.3	V
$V + + IV - I^{(2)}$			13	V
nnut voltage	DIN, FORCEON, FORCEOFF to GND	-0.3	6	V
Input voltage	RIN to GND		±25	v
Outrast sucha an	DOUT to GND		±13.2	V
Output voltage	ROUT, INVALID, READY to GND	-0.3	V _{CC} + 0.3	V
Short-circuit duration	DOUT to GND		Continuous	
	20-pin SSOP (derate 8 mW/°C above 70°C)		640	
Continuous power dissipation ($T_A = 70^{\circ}C$)	20-pin TSSOP (derate 7 mW/°C above 70°C)		559	mW
Storage temperature range			150	°C
Lead temperature (soldering, 10 s)			300	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) V+ and V- can have maximum magnitudes of 7 V, but their absolute difference cannot exceed 13 V.

Recommended Operating Conditions

See Figure 4

				MIN	NOM	MAX	UNIT
	Supply voltage			2.25	2.5	3	V
V _{IH}	Driver and control high-level input voltage	DIN, FORCEOFF, FORCEON	V_{CC} = 2.5 V to 3 V	$0.7 imes V_{CC}$		5.5	V
V _{IL}	Driver and control low-level input voltage	DIN, FORCEOFF, FORCEON	V_{CC} = 2.5 V to 3 V	0		$0.3 \times V_{\text{CC}}$	V
VI	Receiver input voltage			-25		25	V
т	Operating free air temperature	TRS3318EC		0		70	°C
T _A	Operating free-air temperature	TRS3318EI		-40		85	

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Supply Current Section

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature, V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F, T_A = T_{MIN} to T_{MAX} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT	
DC Characteristics ($V_{CC} = 2.5 \text{ V}, T_A = 25^{\circ}\text{C}$)						
Auto-powerdown plus supply current	FORCEON = GND, FORCEOFF = V_{CC} , All RIN and DIN idle		1	10	μA	
Auto-powerdown supply current	FORCEOFF = GND		1	10	μA	
Supply current	FORCEON = $\overline{FORCEOFF}$ = V_{CC} , No load		0.3	2	mA	

(1) Typical values are at V_{CC} = 2.5 V, T_A = 25°C.

ESD Protection

PARAMETER	TEST CONDITIONS	TYP	UNIT
RIN, DOUT	НВМ	±15	
	IEC 61000-4-2 Air-Gap Discharge method	±15	kV
	IEC 61000-4-2 Contact Discharge method	±8	

Driver Section

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,

 V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F, T_A = T_{MIN} to T_{MAX} (unless otherwise noted) (see Figure 4)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
Driver input hysteresis			0.3		V
Input leakage current	FORCEON, DIN, FORCEOFF		±0.01	±1	μA
Output voltage swing	All driver outputs loaded with 3 k Ω to ground	±3.7	±4		V
Output resistance	$V_{CC} = 0$, Driver output = $\pm 2 V$	300	10M		Ω
Output short-circuit current ⁽²⁾			±25	±60	mA
Output leakage current	V_{CC} = 0 or 2.25 V to 3 V, V_{OUT} = ±12 V, Drivers disabled			±25	μA

(1) Typical values are at $V_{CC} = 2.5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. (2) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature,

 V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F, T_A = T_{MIN} to T_{MAX} (unless otherwise noted) (see Figure 1)

	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
	Maximum data rate	$R_L = 3 \text{ k}\Omega$, $C_L = 1000 \text{ pF}$, One transmitter switching	460			kbps
t _{PHL} – t _{PLH}	Driver skew ⁽²⁾			100		ns
	Transition-region slew rate	$\label{eq:VCC} \begin{array}{l} V_{CC} = 2.5 \mbox{ V}, T_A = 25^\circ C, R_L = 3 k\Omega \mbox{ to } 7 k\Omega, \\ \mbox{ Measured from 3 V to } -3 \mbox{ V or } -3 \mbox{ V to 3 V}, \\ C_L = 150 pF \mbox{ to } 2500 pF \end{array}$	4		30	V/µs

Receiver Section

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,

 V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F, T_A = T_{MIN} to T_{MAX} (unless otherwise noted) (see Figure 4)

PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
Input voltage range		-25		25	V
Input threshold low	$T_A = 25^{\circ}C$			$0.3 \times V_{\text{CC}}$	V
Input threshold high	$T_A = 25^{\circ}C$	$0.7 imes V_{CC}$			V
Input hysteresis			0.3		V
Input resistance	$T_A = 25^{\circ}C$	3	5	7	kΩ
Output leakage current			±0.05	±10	μA
Output voltage low	I _{OUT} = 0.5 mA			$0.1 \times V_{CC}$	V
Output voltage high	$I_{OUT} = -0.5 \text{ mA}$	$0.9 imes V_{CC}$			V

(1) Typical values are at V_{CC} = 2.5 V, T_A = 25°C.

Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature, V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F (unless otherwise noted) (see Figure 4)

PARAMETER		TEST CONDITIONS	TYP ⁽¹⁾	UNIT
t _{PHL}	Dessiver propagation delay		0.175	
t _{PLH}	Receiver propagation delay	RIN to ROUT, $C_L = 150 \text{ pF}$	0.175	μs
t _{PHL} – t _{PLH}	Receiver skew ⁽²⁾		50	ns

Auto-Powerdown Plus Section

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,

 $V_{CC} = 2.25$ V to 3 V, C1–C4 = 0.1 μ F, $T_A = T_{MIN}$ to T_{MAX} (unless otherwise noted) (see Figure 4)

PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
Receiver input threshold to INVALID high	Positive threshold		2.7	V
Receiver input threshold to INVALID high	Negative threshold	-2.7		v
Receiver input threshold INVALID low		-0.3	0.3	V
INVALID, READY voltage low	I _{OUT} = 0.5 mA		$0.1 imes V_{CC}$	V
INVALID, READY voltage high	$I_{OUT} = -0.5 \text{ mA}$	$0.8 imes V_{CC}$		V

Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature,

 V_{CC} = 2.25 V to 3 V, C1–C4 = 0.1 μ F, T_A = T_{MIN} to T_{MAX} (unless otherwise noted) (see Figure 4)

	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
t _{INVH}	Receiver positive or negative threshold to INVALID high	V _{CC} = 2.5 V		1		μs
t _{INVL}	Receiver positive or negative threshold to INVALID low	V _{CC} = 2.5 V		30		μs
t _{WU}	Receiver or driver edge to driver enabled	V _{CC} = 2.5 V		100		μs
t _{AUTOPRDN}	Receiver or driver edge to driver shutdown	V _{CC} = 2.5 V	15	30	60	S

(1) Typical values are at $V_{CC} = 2.5$ V, $T_A = 25^{\circ}C$.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s, $Z_0 = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns, $t_f \le 10$ ns.

Figure 1. Driver Slew Rate



TEST CIRCUIT

VOLTAGE WAVEFORMS

NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s, $Z_0 = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns. $t_f \le 10$ ns.

Figure 2. Driver Pulse Skew



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: Z₀ = 50 Ω , 50% duty cycle, t_r \leq 10 ns, t_f \leq 10 ns.

Figure 3. Receiver Propagation Delay Times

Receiver Invalid Inputs Region Driver Inputs Driver Outputs INVALID VCC **t**INVL Output t_{INVH} 0 ► t_{WU} ◄ t_{WU} Vcc Ready 0 Output V+ VCC 0 v **VOLTAGE WAVEFORMS** Valid RS-232 Level, INVALID High ROUT Π 2.7 V Generator **50** Ω Indeterminate (see Note B) 0.3 V If Signal Remains Within This Region 0 V For More Than 30 $\mu \text{s},$ $\overline{\text{INVALID}}$ Is Low[†] -0.3 V Indeterminate Auto-powerdown INVALID Plus -2.7 V C_L = 30 pF Valid RS-232 Level, INVALID High (see Note A) FORCEON-[†] Auto-powerdown disables drivers and reduces supply current to 1 μ A. DOUT DIN FORCEOFF -**TEST CIRCUIT**





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APPLICATION INFORMATION



Figure 5. Typical Application Circuit

26-Sep-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TRS3318ECDB	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBG4	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDB	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBG4	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)



⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TRS3318ECDBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
TRS3318ECPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
TRS3318EIDBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
TRS3318EIPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TRS3318ECDBR	SSOP	DB	20	2000	346.0	346.0	33.0
TRS3318ECPWR	TSSOP	PW	20	2000	346.0	346.0	33.0
TRS3318EIDBR	SSOP	DB	20	2000	346.0	346.0	33.0
TRS3318EIPWR	TSSOP	PW	20	2000	346.0	346.0	33.0

MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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